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ON Semiconductor NTMFS4744NT1G

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# NTMFS4744N

# **Power MOSFET** 30 V, 53 A, Single N-Channel, SO-8 FL

#### **Features**

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These are Pb-Free Devices

#### **Applications**

- CPU Power Delivery
- DC-DC Converters
- Low Side Switching

## **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise stated)

Par	Symbol	Value	Unit		
Drain-to-Source Voltage			V <sub>DSS</sub>	30	V
Gate-to-Source Voltage			V <sub>GS</sub>	20	V
Continuous Drain		T <sub>A</sub> = 25°C	I <sub>D</sub>	11	Α
Current R <sub>θJA</sub> (Note 1)		T <sub>A</sub> = 85°C		8.0	
Power Dissipation $R_{\theta JA}$ (Note 1)		T <sub>A</sub> = 25°C	P <sub>D</sub>	2.2	W
Continuous Drain		T <sub>A</sub> = 25°C	ID	7.0	Α
Current R <sub>θJA</sub> (Note 2)	Steady	T <sub>A</sub> = 85°C		5.0	
Power Dissipation $R_{\theta JA}$ (Note 2)	State	T <sub>A</sub> = 25°C	P <sub>D</sub>	0.88	W
Continuous Drain		T <sub>C</sub> = 25°C	I <sub>D</sub>	53	Α
Current R <sub>θJC</sub> (Note 1)		T <sub>C</sub> = 85°C		38	
Power Dissipation R <sub>0JC</sub> (Note 1)		T <sub>C</sub> = 25°C	P <sub>D</sub>	47.2	W
Pulsed Drain Current	t <sub>p</sub> =10μs	T <sub>A</sub> = 25°C	I <sub>DM</sub>	106	Α
Operating Junction a	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C		
Source Current (Boo	I <sub>S</sub>	46	Α		
Drain to Source dV/	dV/dt	6.0	V/ns		
Single Pulse Drain-to-Source Avalanche Energy ( $V_{DD}$ = 50 V, $V_{GS}$ = 10 V, $I_L$ = 24 $A_{pk}$ , $L$ = 1.0 mH, $R_G$ = 25 $\Omega$ )			EAS	286	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			T <sub>L</sub>	260	°C

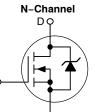
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

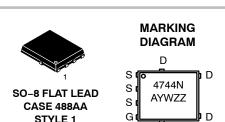


## ON Semiconductor®

#### http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX	
30 V	10 mΩ @ 10 V	53 A	
30 V	14 mΩ @ 4.5 V	30 A	





4744N = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTMFS4744NT1G	SO-8 FL (Pb-Free)	1500 Tape & Reel
NTMFS4744NT3G	SO-8 FL (Pb-Free)	5000 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Datasheet of NTMFS4744NT1G - MOSFET N-CH 30V 7A SO-8FL

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## THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ heta JC}$	2.65	
Junction-to-Ambient - Steady State (Note 1)	$R_{ hetaJA}$	56.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{ hetaJA}$	142.4	

- 1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
- 2. Surface-mounted on FR4 board using the minimum recommended pad size.

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-			-
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /				10		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25 °C				1.0	1 .
		V <sub>DS</sub> = 24 V	T <sub>J</sub> = 125°C			10	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS}$	s = 20 V			100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 250 \mu A$		1.5		2.5	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				5.0		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V to	I <sub>D</sub> = 30 A		7.6		
		11.5 V	I <sub>D</sub> = 15 A		7.3		1
			I <sub>D</sub> = 10 A		7.3	10	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 30 A		10.4		mΩ
			I <sub>D</sub> = 15 A		10.1		1
			I <sub>D</sub> = 10 A		9.9	14	1
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A			25		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE						
Input Capacitance	C <sub>ISS</sub>				1300		
Output Capacitance	Coss	$V_{GS} = 0 \text{ V, f} = 1 \text{ MHz, } V_{DS} = 12 \text{ V}$			550		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				132		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			10	17	
Threshold Gate Charge	Q <sub>G(TH)</sub>				0.9		1 _
Gate-to-Source Charge	$Q_{GS}$				1.8		nC
Gate-to-Drain Charge	$Q_{GD}$				5.9		1
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 11.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			25	37	nC
SWITCHING CHARACTERISTICS (Note 4)							
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS} = 4.5 \text{ V}, V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}, R_G = 3.0 \Omega$			12		
Rise Time	t <sub>r</sub>				203		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				14		ns
	1			<del></del>	<del></del>		1

3. Pulse Test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%.

Fall Time

Switching characteristics are independent of operating junction temperatures.

Datasheet of NTMFS4744NT1G - MOSFET N-CH 30V 7A SO-8FL

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# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (No	ote 4)			•	•	•	•
Turn-On Delay Time	t <sub>d(ON)</sub>			7.0		- ns	
Rise Time	t <sub>r</sub>	$V_{GS}$ = 11.5 V, $V_{DS}$ = 15 V, $I_{D}$ = 30 A, $R_{G}$ = 3.0 $\Omega$			94		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				23		
Fall Time	t <sub>f</sub>				4.7		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 30 A	T <sub>J</sub> = 25°C		0.78	1.2	V
			T <sub>J</sub> = 125°C		0.7		
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 30 \text{ A}$			37	60	
Charge Time	t <sub>a</sub>				21		ns
Discharge Time	t <sub>b</sub>				17		
Reverse Recovery Charge	$Q_{RR}$				37		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L <sub>S</sub>	T <sub>A</sub> = 25°C			0.65		nΗ
Drain Inductance	L <sub>D</sub>				0.005		
Gate Inductance	L <sub>G</sub>				1.84		
Gate Resistance	$R_{G}$				2.0	5.0	Ω

Pulse Test: pulse width ≤ 300 µs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

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# NTMFS4744N

## **TYPICAL PERFORMANCE CURVES**

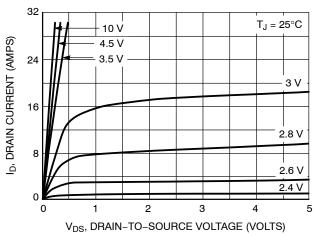


Figure 1. On-Region Characteristics

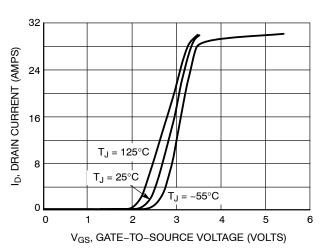


Figure 2. Transfer Characteristics

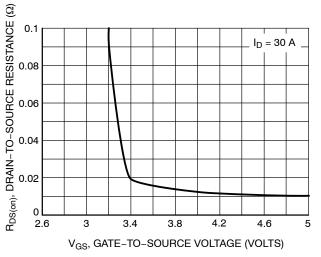


Figure 3. On-Resistance vs. Gate-to-Source Voltage

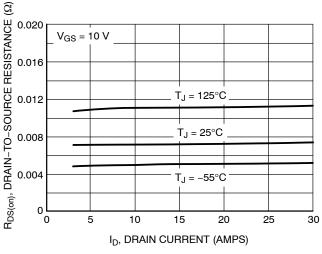


Figure 4. On–Resistance vs. Drain Current and Temperature

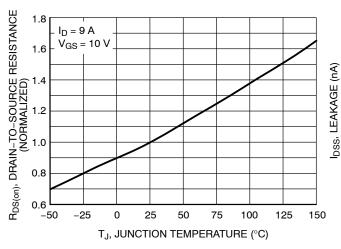


Figure 5. On–Resistance Variation with Temperature

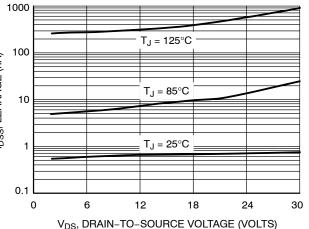
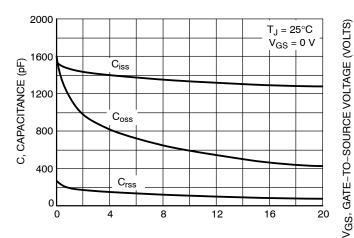


Figure 6. Drain-to-Source Leakage Current vs. Drain Voltage

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#### **TYPICAL PERFORMANCE CURVES**



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

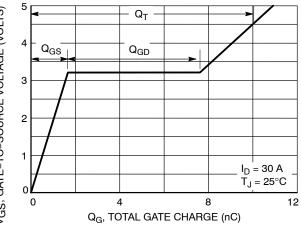


Figure 8. Gate-To-Source and Drain-To-Source Voltage vs. Total Charge



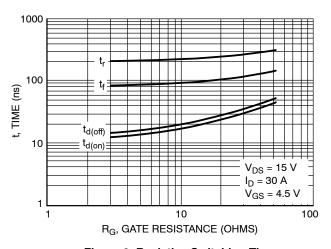


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

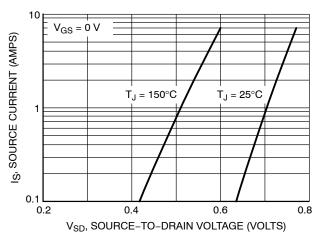


Figure 10. Diode Forward Voltage vs. Current

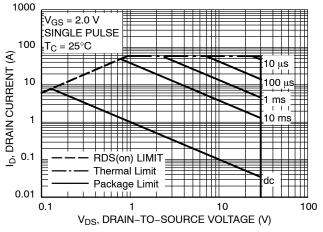


Figure 11. Maximum Rated Forward Biased Safe Operating Area

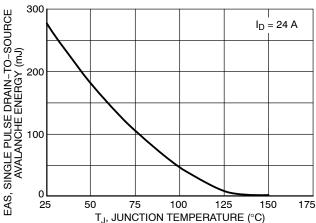


Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature

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## **TYPICAL PERFORMANCE CURVES**

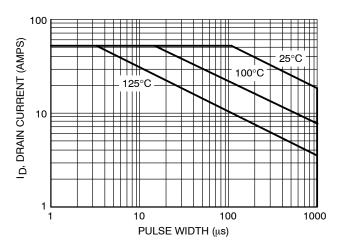


Figure 13. Avalanche Characteristics

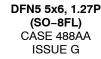


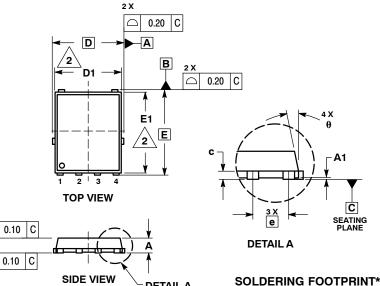
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## NTMFS4744N

#### PACKAGE DIMENSIONS





- TES:
  DIMENSIONING AND TOLERANCING PER
  ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION D1 AND E1 DO NOT INCLUDE
  MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS				
DIM	MIN	MOM	MAX		
Α	0.90	1.00	1.10		
A1	0.00		0.05		
b	0.33	0.41	0.51		
С	0.23	0.28	0.33		
D		5.15 BSC	;		
D1	4.50	4.90	5.10		
D2	3.50		4.22		
Е	6.15 BSC				
E1	5.50	5.80	6.10		
E2	3.45		4.30		
е	1.27 BSC				
G	0.51	0.61	0.71		
K	1.20	1.35	1.50		
L	0.51	0.61	0.71		
L1	0.05	0.17	0.20		
М	3.00	3.40	3.80		
θ	0 °		12 °		

.000

4.530

- STYLE 1: PIN 1. SOURCE
  - SOURCE SOURCE GATE

  - 5. DRAIN
- **←**0.750 8X **b** Α В 0.10 С Ф 0.05 C e/2 0.965 1.330 0.905 2X E2 0.495 PIN 5 (EXPOSED PAD) М 3.200 0.475 G D2 2X **BOTTOM VIEW →** 1.530 4.560

**DETAIL A** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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